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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	M8C
Core Size	8-Bit
Speed	12MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c21312-12pvxe



Contents

PSoC Functional Overview	3
The PSoC Core	3
The Digital System	3
The Analog System	
Additional System Resources	4
PSoC Device Characteristics	5
Getting Started	5
Application Notes	
Development Kits	5
Training	
CYPros Consultants	
Solutions Library	5
Technical Support	5
Development Tools	6
PSoC Designer Software Subsystems	6
Designing with PSoC Designer	7
Select Components	7
Configure Components	7
Organize and Connect	7
Generate, Verify, and Debug	7
Pinouts	8
20-pin Part Pinout	8
28-pin Part Pinout	
Registers	10
Register Conventions	10
Register Mapping Tables	10
Absolute Maximum Ratings	13
Operating Temperature	13
Electrical Specifications	14

DC Electrical Characteristics	15
AC Electrical Characteristics	18
Development Tool Selection	23
Software	
Development Kits	23
Evaluation Tools	23
Device Programmers	23
Accessories (Emulation and Programming)	24
Ordering Information	
Ordering Code Definitions	25
Packaging Information	26
Packaging Dimensions	26
Tape and Reel Information	28
Thermal Impedances	30
Solder Reflow Specifications	30
Reference Information	31
Reference Documents	31
Acronyms	32
Document Conventions	32
Units of Measure	32
Numeric Conventions	32
Glossary	33
Document History Page	37
Sales, Solutions, and Legal Information	
Worldwide Sales and Design Support	38
Products	38
PSoC Solutions	38



PSoC Functional Overview

The PSoC family consists of many devices with on-chip controllers. These devices are designed to replace multiple traditional microcontroller unit (MCU)-based system components with one, low-cost single-chip programmable component. A PSoC device includes configurable blocks of analog and digital logic, and programmable interconnect. This architecture makes it possible for you to create customized peripheral configurations, to match the requirements of each individual application. Additionally, a fast CPU, flash program memory, SRAM data memory, and configurable I/O are included in a range of convenient pinouts.

The PSoC architecture, as illustrated in the Logic Block Diagram on page 1, comprises of four main areas: the core, the system resources, the digital system, and the analog system. Configurable global bus resources allow all the device resources to be combined into a complete custom system. Each CY8C21x12 device includes one limited digital block and one CapSense block. Depending on the PSoC package, up to 24 GPIOs are also included. The GPIOs provide access to the global digital and analog interconnects.

The PSoC Core

The PSoC core is a powerful engine that supports a rich instruction set. It encompasses SRAM for data storage, an interrupt controller, sleep, and watchdog timers, and an internal main oscillator (IMO) and internal low-speed oscillator (ILO). The CPU core, called the M8C, is a powerful processor with speeds up to 24 MHz. The M8C is a four-million instructions per second (MIPS) 8-bit Harvard-architecture microprocessor.

System Resources provide additional capability, such as digital clocks for increased flexibility, I²C functionality for implementing an I²C master, slave, or multi-master, an internal voltage reference that provides an absolute value of 1.3 V to a number of PSoC subsystems, and various system resets supported by the M8C.

The Digital System is composed of a programmable limited digital block and fixed-function digital resources inside the CapSense block. The limited digital block can be configured into a number of digital peripherals. The fixed-function digital resources in the CapSense block provide external modulation signals, measurement timing, and measurement conversion. The digital resources can be connected to the GPIO through a series of global buses that provide very flexible routing options.

The Analog System is composed of a comparator and a filter that are used in the CapSense block in order to implement capacitive sensing measurement.

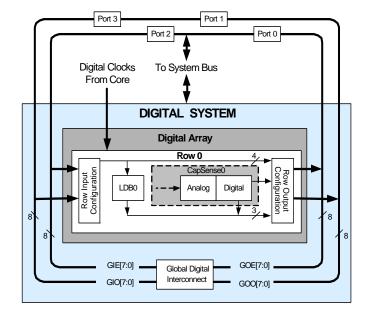
The Digital System

The digital system is composed of one digital block. This block is an 8-bit resource that can implement various 8-bit digital peripherals. Digital peripheral configurations include those listed.

- PWM (8-bit)
- Counter (8-bit)
- Timer (8-bit)
- Half-duplex 8-bit UART with selectable parity
- SPI slave
- I²C master, slave, or multi-master (implemented in a dedicated I²C block)

The digital block can be connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Figure 1. Digital System Block Diagram



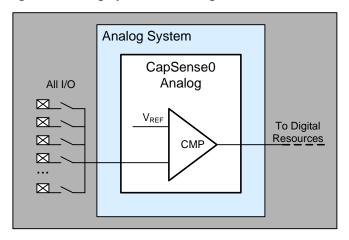


The Analog System

The analog system is composed of analog resources inside of the CapSense block. These resources are used to implement a flexible capacitive sensing and measurement module. The analog resources in the CapSense block are listed.

- Comparator used in capacitance-to-digital conversion
- Fixed, absolute reference or adjustable, ratiometric reference can be used with the comparator
- Low-pass filter converts a digital bit stream into the adjustable, ratiometric analog reference

Figure 2. Analog System Block Diagram



The Analog Multiplexer System

The analog mux bus can connect to every GPIO pin. Pins can be connected to the bus individually or in any combination. The bus also connects to the analog system. Switch-control logic enables selected pins to precharge continuously under hardware control. This enables capacitive measurement for applications such as touch sensing. Other multiplexer applications include:

- Track pad, finger sensing.
- Chip-wide mux that allows analog input from any I/O pin.
- Crosspoint connection between any I/O pin combination.

Additional System Resources

System resources, some of which have been previously listed, provide additional capability useful for complete systems. Brief statements describing the merits of each system resource are presented.

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems.
- The I²C module provides communication up to 400 kHz over two wires. Slave, master, and multi-master modes are all supported.
- LVD interrupts can signal the application of falling voltage levels, while the advanced power-on reset (POR) circuit eliminates the need for a system supervisor.
- An internal 1.3 V voltage reference provides an absolute reference for the analog system.
- Versatile analog multiplexer system.



Development Tools

PSoC Designer™ is the revolutionary integrated design environment (IDE) that you can use to customize PSoC to meet your specific application requirements. PSoC Designer software accelerates system design and time to market. Develop your applications using a library of precharacterized analog and digital peripherals (called user modules) in a drag-and-drop design environment. Then, customize your design by leveraging the dynamically generated application programming interface (API) libraries of code. Finally, debug and test your designs with the integrated debug environment, including in-circuit emulation and standard software debug features. PSoC Designer includes:

- Application editor graphical user interface (GUI) for device and user module configuration and dynamic reconfiguration
- Extensive user module catalog
- Integrated source-code editor (C and assembly)
- Free C compiler with no size restrictions or time limits
- Built-in debugger
- In-circuit emulation
- Built-in support for communication interfaces:
 - ☐ Hardware and software I²C slaves and masters
 - □ Full-speed USB 2.0
 - □ Up to four full-duplex universal asynchronous receiver/transmitters (UARTs), SPI master and slave, and wireless

PSoC Designer supports the entire library of PSoC 1 devices and runs on Windows XP, Windows Vista, and Windows 7.

PSoC Designer Software Subsystems

Design Entry

In the chip-level view, choose a base device to work with. Then select different onboard analog and digital components that use the PSoC blocks, which are called user modules. Examples of user modules are ADCs, DACs, amplifiers, and filters. Configure the user modules for your chosen application and connect them to each other and to the proper pins. Then generate your project. This prepopulates your project with APIs and libraries that you can use to program your application.

The tool also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic reconfiguration makes it possible to change configurations at run time. In essence, this allows you to use more than 100 percent of PSoC's resources for an application.

Code Generation Tools

The code generation tools work seamlessly within the PSoC Designer interface and have been tested with a full range of debugging tools. You can develop your design in C, assembly, or a combination of the two.

Assemblers. The assemblers allow you to merge assembly code seamlessly with C code. Link libraries automatically use absolute addressing or are compiled in relative mode, and are linked with other software modules to get absolute addressing.

C Language Compilers. C language compilers are available that support the PSoC family of devices. The products allow you to create complete C programs for the PSoC family devices. The optimizing C compilers provide all of the features of C, tailored to the PSoC architecture. They come complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

Debugger

PSoC Designer has a debug environment that provides hardware in-circuit emulation, allowing you to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow you to read and program and read and write data memory, and read and write I/O registers. You can read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows you to create a trace buffer of registers and memory locations of interest.

Online Help System

The online help system displays online, context-sensitive help. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an online support Forum to aid the designer.

In-Circuit Emulator

A low-cost, high-functionality in-circuit emulator (ICE) is available for development support. This hardware can program single devices.

The emulator consists of a base unit that connects to the PC using a USB port. The base unit is universal and operates with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full-speed (24 MHz) operation.

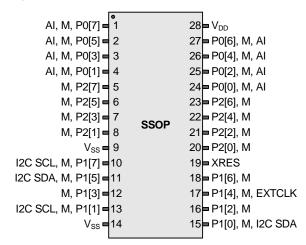


28-pin Part Pinout

Table 3. 28-pin Part Pinout (SSOP)

Pin Type		Туре		December 1			
No.	Digital	Analog	Name	Description			
1	I/O	I, M	P0[7]	Analog column mux input			
2	I/O	I, M	P0[5]	Analog column mux input			
3	I/O	I, M	P0[3]	Analog column mux input, C _{MOD} capacitor pin			
4	I/O	I, M	P0[1]	Analog column mux input, C _{MOD} capacitor pin			
5	I/O	М	P2[7]				
6	I/O	М	P2[5]				
7	I/O	М	P2[3]				
8	I/O	М	P2[1]				
9	Pov	wer	V_{SS}	Ground connection			
10	I/O	М	P1[7]	I ² C SCL			
11	I/O	М	P1[5]	I ² C SDA			
12	I/O	М	P1[3]				
13	I/O	М	P1[1]	I ² C SCL, ISSP-SCLK ^[5]			
14	Pov	Power V _{SS}		Ground connection			
15	I/O	М	P1[0]	I ² C SDA, ISSP-SDATA ^[5]			
16	I/O	М	P1[2]				
17	I/O	М	P1[4]	Optional EXTCLK			
18	I/O	М	P1[6]				
19	Inp	out	XRES	Active high external reset with internal pull-down			
20	I/O	М	P2[0]				
21	I/O	М	P2[2]				
22	I/O	М	P2[4]				
23	I/O	М	P2[6]				
24	I/O	I, M	P0[0]	Analog column mux input			
25	I/O	I, M	P0[2]	Analog column mux input			
26	I/O	I, M	P0[4]	Analog column mux input			
27	I/O	I, M	P0[6]	Analog column mux input			
28	Pov	wer	V_{DD}	Supply voltage			

Figure 4. CY8C21512 28-pin PSoC Device



LEGEND: A = Analog, I = Input, O = Output, and M = Analog Mux Input.

Note

^{5.} These are the ISSP pins, which are not high Z when coming out of POR. See the PSoC Technical Reference Manual for details.



Name (0,Hex) Name (0,Hex) Name (0,Hex) Name (0,Hex) Name (0,Hex) Name (0,Hex) Name Name (0,Hex) Name	rabie 4. Registe	able 4. Register Map 0 Table: User Space										
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PRITOSS 02 RW 42 42 82 62 C2 PRITOMAZ 03 RW 44 45 CSREF_CR1 84 RW C4 CSREF_CR1 84 RW C4 CSREF_CR1 84 RW C4 CSREF_CR1 85 CS	PRT0DR		RW									
RRIONNIZ 033 RW 443 CSREF_CRT 635 RW 445 CSREF_CRT 645 RW 446 CSREF_CRT 655 CS RW 477 677 CT RRITIER 050 RW 440 680 CC6 RRITIONIZ 077 RW 447 677 C77 RRITIER 081 RW 449 683 CC5 RRITIONIZ 078 RW 449 683 CC7 RRITICR 081 RW 449 683 CC7 RRITICR 081 RW 449 683 CC7 RRITICR 082 RW 449 683 CC7 RRITICR 083 RW 449 683 CC7 RRITICR 084 RW 449 685 CC7 RRITICR 085 RW 449 685 CC7 RRITICR 086 RW 449 686 CC7 RRITICR 087 RW 449 687 CC8 CC8 RRITICR CC8 CC8 RRITICR CC8 CC8 RRITICR CC8 CC8 CC8 CC8 CC8 CC8 CC9	PRT0IE	01	RW		41			81			C1	
PRITION 04 RW 44 CSREF CRI 64 RW CA CA PRITION 05 RW 45 S C C5 STRITION 05 RW 45 S C C5 STRITION 05 RW 45 S C C6 PRITION 05 RW	PRT0GS	02	RW		42			82			C2	
PRITION 04 RW 44 CSREF CRI 64 RW CA CA PRITION 05 RW 45 S C C5 STRITION 05 RW 45 S C C5 STRITION 05 RW 45 S C C6 PRITION 05 RW	PRT0DM2	03			43			83			C3	
PRT11E 05 RW 45 85 C5 PRT11D				1			CSRFF CR1		RW			
RRTIOSS							OCKET_CKT					
PRITIDNIZ 97												
PRIZER 08 RW 48 89 89 C9 PRIZES 09 RW 48 88 88 C9 PRIZES 09 RW 48 89 89 C9 PRIZES 06 RW 44 88 88 C6 C6 C6 C7 C7 C8 C7 C8 C8 C7 C7 C8 C8 C8 C9 C8 C9												
PRIZES 09 RW 49 49 89 80 C2 APRIZES OA RW 4A 8B 8B CA CA PRIZES OA RW 4B 8B 8B CA CA CB												
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OC		0A										
OD	PRT2DM2	0B	RW		4B			8B			СВ	
OF		0C			4C			8C			CC	
OF		0D			4D			8D			CD	
10		0E		1	4E			8E			CE	
10		0F			4F			8F			CF	
11		_		1						CUR PP		RW
12												
13										011C_11		17.00
14							ļ			IDA DD		D)A/
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16												
17												
18												RW
19		17			57			97			D7	#
1A		18			58			98		I2C_DR	D8	RW
18		19			59			99		I2C_MSCR	D9	#
1C		1A			5A			9A			DA	RW
1C		1B			5B			9B		INT CLR1	DB	RW
1D				1								
1E										INT CLR3		RW
SCENT_DRO												
CSCNT_DR0 20 # 60 A0 INT_MSK0 E0 RW CSCNT_DR1 21 W AMUX_CFG 61 RW A1 INT_MSK1 E1 RW CSCNT_DR2 22 RW CSCMP_CR0 62 RW A2 INT_WC E2 RC CSSNT_DR0 23 # CSCMP_CR1 64 # A3 RES_WDT E3 W CSMODD_DR0 24 # CSCMP_CR1 64 # A4 E4 CSCMP_CR5 E6 RW CSMODD_DR1 25 W CSCMP_CR2 66 RW A6 CSCMP_CR5 E6 RW CSMODI_DR0 27 # 67 A7 CSCMP_CR6 E7 RW CSMODI_DR1 29 W CSREF_CR0 69 # A9 E8 E8 CSMODI_DR2 2A RW GA AA EA EA CSMODI_DR1 29 W <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>IIVI_IVIONO</td> <td></td> <td>KVV</td>										IIVI_IVIONO		KVV
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CSCNT_DR2 22 RW CSCMP_CR0 62 RW A2 INT_VC E2 RC CSCNT_CR0 23 # CSCMP_CR1 64 # A3 RES_WDT E3 W CSMODD_DR1 25 W 65 RW A6 CSCMP_CR5 E6 RW CSMODD_DR2 26 RW CSCMP_CR2 66 RW A6 CSCMP_CR5 E6 RW CSMODD_DR0 27 # 67 A7 CSCMP_CR6 E7 RW CSMOD1_DR0 28 # 68 A8 A8 E8 E8 CSMOD1_DR1 29 W CSREF_CR0 69 # A9 E9 CSMDT_CR0 E8 E8 E8 CSMOD1_DR1 29 W CSREF_CR0 68 # A8 E8 E8 E8 E8 CSMOD1_CR0 E8 # E8 LDBD_CR0 E8 # AB LDBD_CR0 E8												
CSCNT_CRO												
CSMOD_DR0		22	RW	CSCMP_CR0	62	RW		A2			E2	RC
CSMOD0_DR1	CSCNT_CR0	23	#		63			A3		RES_WDT	E3	W
CSMOD_DR2 26 RW CSCMP_CR2 66 RW A6 CSCMP_CR5 E6 RW CSMODL_DR0 27 # 67 A7 CSCMP_CR6 E7 RW CSMODL_DR0 28 # 68 A8 A8 E8 CSMODL_DR1 29 W CSREF_CR0 69 # A9 E9 CSMODL_DR1 29 W CSREF_CR0 69 # A9 E9 CSMODL_DR1 29 W CSREF_CR0 69 # A9 E9 CSMODL_CR0 28 # 6B AA AA EA CSMODL_CR0 28 # MB_DR0 6C RW AC EC LDB0_DR0 2C # TMP_DR1 6D RW AE EE LDB0_CR0 2F # TMP_DR3 6F RW AE EF LDB0_CR0 2F # TMP_DR3 6F RW </td <td>CSMOD0_DR0</td> <td>24</td> <td>#</td> <td>CSCMP_CR1</td> <td>64</td> <td>#</td> <td></td> <td>A4</td> <td></td> <td></td> <td>E4</td> <td></td>	CSMOD0_DR0	24	#	CSCMP_CR1	64	#		A4			E4	
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CSMOD1_CR0 2B # 6B AB AB EB LDB0_DR0 2C # TMP_DR0 6C RW AC EC LDB0_DR1 2D W TMP_DR1 6D RW AD ED LDB0_DR2 2E RW TMP_DR2 6E RW AE EE LDB0_CR0 2F # TMP_DR3 6F RW AF EF 30 70 RDIORI BO RW F0 31 71 RDIOSYN B1 RW F1 32 72 RDIOIS B2 RW F2 33 73 RDIOLTO B3 RW F3 34 74 RDIOLTO B3 RW F4 35 75 RDIOROO B5 RW F6 36 CSCMP_CR3 76 RW RDIOROO B6 RW F6 38 78 B8	_			CORLI _CIRO		π						
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LDB0_DR1 2D W TMP_DR1 6D RW AD ED LDB0_DR2 2E RW TMP_DR2 6E RW AE EE LDB0_CR0 2F # TMP_DR3 6F RW AF EF 30 70 RDIORI BO RW FO 31 71 RDIOSYN B1 RW F1 32 72 RDIOIS B2 RW F2 33 73 RDIOLTO B3 RW F3 34 74 RDIORO B5 RW F4 35 75 RDIOROO B5 RW F5 36 CSCMP_CR3 76 RW RDIOROI B6 RW F6 37 CSCMP_CR4 77 RW B7 CPU_F F7 RL 38 78 B8 B8 F8 39 79 B9 F9 F9 <td>_</td> <td></td> <td></td> <td>THE DEC</td> <td></td> <td>D</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>	_			THE DEC		D						
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34 74 RDIOLT1 B4 RW F4 35 75 RDIOROO B5 RW F5 36 CSCMP_CR3 76 RW RDIORO1 B6 RW F6 37 CSCMP_CR4 77 RW B7 CPU_F F7 RL 38 78 B8 B8 F8 39 79 B9 F9 3A 7A BA FA 3B 7B BB BB FB 3C 7C BC FC 3D 7D BD FD 3E 7E BE CPU_SCR1 FE # 3F 7F BF CPU_SCR0 FF #						 						
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3A 7A BA FA 3B 7B BB FB 3C 7C BC FC 3D 7D BD FD 3E 7E BE CPU_SCR1 FE # 3F 7F BF CPU_SCR0 FF #												
3B 7B BB FB 3C 7C BC FC 3D 7D BD FD 3E 7E BE CPU_SCR1 FE # 3F 7F BF CPU_SCR0 FF #												
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Blank fields are Reserved and must not be accessed.

Access is bit specific.



DC Electrical Characteristics

DC Chip-Level Specifications

Table 8 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{A} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 8. DC Chip-Level Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
V_{DD}	Supply voltage	3	_	5.25	V	See Table 12 on page 16.
I _{DD}	Supply current, IMO = 24 MHz	-	4	8	mA	Conditions are $V_{DD}=5.25$ V, -40 °C \leq T _A \leq 125 °C, CPU = 3 MHz, 48 MHz disabled. VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.366 kHz.
I _{DD3}	Supply current, IMO = 24 MHz	-	4	8	mA	Conditions are V_{DD} = 3.3 V, -40 °C ≤ TA ≤ 125 °C, CPU = 3 MHz, 48 MHz disabled. VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.366 kHz.
I _{SB}	Sleep (mode) current with POR, LVD, sleep timer, WDT, and ILO active. Mid temperature range.	_	5	12	μА	$V_{DD} = 5.25 \text{ V}, -40 \text{ °C} \le T_A \le 55 \text{ °C}.$
I _{SBH}	Sleep (mode) current with POR, LVD, sleep timer, WDT, and ILO active. High temperature range.	-	5	100	μА	$V_{DD} = 5.25 \text{ V}, 55 \text{ °C} \le T_A \le 125 \text{ °C}.$
V_{REF}	Reference voltage (Bandgap)	1.25	1.30	1.35	V	

DC GPIO Specifications

Table 9 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{A} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 9. DC GPIO Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
R _{PU}	Pull-up resistor	4	5.6	8	kΩ	
R _{PD}	Pull-down resistor	4	5.6	8	kΩ	Also applies to the internal pull-down resistor on the XRES pin
V _{OH}	High output level	V _{DD} – 1.0	-	_	V	I_{OH} = 10 mA, V_{DD} = 4.75 to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])).
V _{OL}	Low output level	-	-	0.75	V	I_{OL} = 25 mA, V_{DD} = 4.75 to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])).
I _{OH}	High level source current	10	_	_	mA	$V_{OH} \ge V_{DD} - 1.0 \text{ V}$, see the limitations of the total current in the note for V_{OH} .
I _{OL}	Low level sink current	25	-	_	mA	$V_{OL} \le 0.75$ V, see the limitations of the total current in the note for V_{OL} .
V_{IL}	Input low level	_	_	0.8	V	
V_{IH}	Input high level	2.1	_		V	
V_{H}	Input hysteresis	_	60	-	mV	
I _{IL}	Input leakage (absolute value)	-	1	_	nA	Gross tested to 1 μA.
C _{IN}	Capacitive load on pins as input	_	3.5	10	pF	Package and pin dependent. T _A = 25 °C.
C _{OUT}	Capacitive load on pins as output	_	3.5	10	pF	Package and pin dependent. T _A = 25 °C.

Document Number: 001-81890 Rev. *B



DC Operational Amplifier Specifications

Table 10 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and -40 °C ≤ T_A ≤ 125 °C or 3.0 V to 3.6 V and -40 °C ≤ TA ≤ 125 °C, respectively. Typical parameters apply to 5 V or 3.3 V at 25 °C and are for design guidance only.

Table 10. DC Operational Amplifier Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
V _{OSOA}	Input offset voltage (absolute value)	-	2.5	15	mV	
TCV _{OSOA}	Average input offset voltage drift	_	10	_	μV/°C	
I _{EBOA} ^[6]	Input leakage current (Port 0 analog pins)	_	200	_	рА	Gross tested to 1 μA.
C _{INOA}	Input capacitance (Port 0 analog pins)	_	4.5	9.5	pF	Package and pin dependent. T _A = 25 °C.
V_{CMOA}	Common mode voltage range	0.0	_	V _{DD} – 1	V	
G _{OLOA}	Open loop gain	_	80	_	dB	
I _{SOA}	Amplifier supply current	-	10	100	μА	

DC Analog Mux Bus Specifications

Table 11 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and -40 °C ≤ T_A ≤ 125 °C or 3.0 V to 3.6 V and -40 °C ≤ TA ≤ 125 °C, respectively. Typical parameters apply to 5 V or 3.3 V at 25 °C and are for design guidance only.

Table 11. DC Analog Mux Bus Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
344	Switch resistance to common analog bus	-	-	400	Ω	
טט	Resistance of initialization switch to V_{DD}	-	-	800	Ω	

DC POR and LVD Specifications

Table 12 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and -40 °C ≤ T_A ≤ 125 °C or 3.0 V to 3.6 V and -40 °C ≤ TA ≤ 125 °C, respectively. Typical parameters apply to 5 V or 3.3 V at 25 °C and are for design guidance only.

Table 12. DC POR and LVD Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
	V _{DD} value for PPOR trip					V _{DD} must be greater than or equal
V_{PPOR0}	PORLEV[1:0] = 00b	_	2.36	2.40	V	to 2.5 V during startup, reset from
V _{PPOR1}	PORLEV[1:0] = 01b	_	2.82	2.95	V	the XRES pin, or reset from
V _{PPOR2}	PORLEV[1:0] = 10b	_	4.55	4.70	V	watchdog.
	V _{DD} value for LVD trip			[7]		
V_{LVD0}	VM[2:0] = 000b	2.40	2.45	2.51 ^[7]	V	
V_{LVD1}	VM[2:0] = 001b	2.85	2.92	2.99 ^[8]	V	
V_{LVD2}	VM[2:0] = 010b	2.95	3.02	3.09	V	
V_{LVD3}	VM[2:0] = 011b	3.06	3.13	3.20	V	
V_{LVD4}	VM[2:0] = 100b	4.37	4.48	4.55	V	
V _{LVD5}	VM[2:0] = 101b	4.50	4.64	4.75	V	
V _{LVD6}	VM[2:0] = 110b	4.62	4.73	4.83	V	
V _{LVD7}	VM[2:0] = 111b	4.71	4.81	4.95	V	

- 6. Atypical behavior: I_{EBOA} of Port 0 Pin 0 is below 1 nA at 25 °C; 50 nA over temperature. Use Port 0 Pins 1-7 for the lowest leakage of 200 pA.
- 7. Always greater than 50 mV above V_{PPOR0} (PORLEV[1:0] = 00b) for falling supply. 8. Always greater than 50 mV above V_{PPOR1} (PORLEV[1:0] = 01b) for falling supply.



DC Programming Specifications

Table 13 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 13. DC Programming Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
V_{DDP}	V _{DD} for programming and erase	4.5	5	5.5	V	This specification applies to the functional requirements of external programmer tools
V_{DDLV}	Low V _{DD} for verify	3	3.1	3.2	V	This specification applies to the functional requirements of external programmer tools
V_{DDHV}	High V _{DD} for verify	5.1	5.2	5.3	V	This specification applies to the functional requirements of external programmer tools
V _{DDIWRITE}	Supply voltage for flash write operation	3	_	5.25	V	This specification applies to this device when it is executing internal flash writes
I _{DDP}	Supply current during programming or verify	_	5	25	mA	
V _{ILP}	Input low voltage during programming or verify	_	-	0.8	V	
V _{IHP}	Input high voltage during programming or verify	2.2	-	_	V	
I _{ILP}	Input current when applying V _{ILP} to P1[0] or P1[1] during programming or verify	-	_	0.2	mA	Driving internal pull-down resistor.
I _{IHP}	Input current when applying V _{IHP} to P1[0] or P1[1] during programming or verify	-	_	1.5	mA	Driving internal pull-down resistor.
V _{OLV}	Output low voltage during programming or verify	_	_	0.75	V	
V _{OHV}	Output high voltage during programming or verify	V _{DD} – 1	-	V _{DD}	V	
Flash _{ENPB}	Flash endurance (per block) [9]	100	_	_	-	Erase/write cycles per block.
Flash _{ENT}	Flash endurance (total) [9, 10]	12,800	-	_	_	Erase/write cycles.
Flash _{DR}	Flash data retention [11]	15	_	_	Years	

For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) or other temperature sensor, and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note AN2015 for more information.

^{10.} The maximum total number of allowed erase/write cycles is the minimum Flash_{ENPB} value multiplied by the number of flash blocks in the device. 11. Flash data retention based on the use condition of \leq 7000 hours at $T_A \leq$ 125 °C and the remaining time at $T_A \leq$ 65 °C.



AC Electrical Characteristics

AC Chip-Level Specifications

Table 14 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le T_{A} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le TA \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 14. AC Chip-Level Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
F _{IMO24}	IMO frequency for 24 MHz	22.8 ^[12]	24	25.2 ^[12]	MHz	Trimmed using factory trim values. See Figure 6 on page 14. SLIMO mode = 0.
F _{IMO6}	IMO frequency for 6 MHz	5.5 ^[12]	6	6.5 ^[12]	MHz	Trimmed using factory trim values. See Figure 6 on page 14. SLIMO mode = 1.
F _{CPU1}	CPU frequency (5 V V _{DD} nominal)	0.09 ^[12]	12	12.6 ^[12]	MHz	SLIMO mode = 0.
F _{BLK5}	Digital PSoC block frequency (5 V V _{DD} nominal)	0	24	25.2 ^[12]	MHz	Refer to Table 17 on page 20.
F _{BLK33}	Digital PSoC block frequency (3.3 V V _{DD} nominal)	0	24	25.2 ^[12]	MHz	Refer to Table 17 on page 20.
F _{32K1}	ILO frequency	15	32	64	kHz	This specification applies when the ILO has been trimmed.
F _{32KU}	ILO untrimmed frequency	5	_	100	kHz	After a reset and before the M8C processor starts to execute, the ILO is not trimmed.
t _{XRST}	External reset pulse width	10	_	_	μS	
DC24M	24 MHz duty cycle	40	50	60	%	
DC _{ILO}	ILO duty cycle	20	50	80	%	
Step24M	24 MHz trim step size	_	50	-	kHz	
F _{MAX}	Maximum frequency of signal on row input or row output.	-	_	12.6 ^[12]	MHz	
SR _{POWERUP}	Power supply slew rate	_	_	250	V/ms	V _{DD} slew rate during power up.
t _{POWERUP}	Time between end of POR state and CPU code execution	-	16	100	ms	Power-up from 0 V.
t _{JIT_IMO} ^[13]	24 MHz IMO cycle-to-cycle jitter (RMS)	-	200	700	ps	
	24 MHz IMO long term N cycle-to-cycle jitter (RMS)	_	300	900		N = 32
	24 MHz IMO period jitter (RMS)	-	100	400		

Accuracy derived from Internal Main Oscillator with appropriate trim for V_{DD} range.
 Refer to Cypress Jitter Specifications document, Understanding Datasheet Jitter Specifications for Cypress Timing Products, for more information.



AC GPIO Specifications

Table 15 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{A} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 15. AC GPIO Specifications

Symbol	Description	Min	Тур	Max	Units	Notes	
F _{GPIO}	GPIO operating frequency	0	_	12.6 ^[14]	MHz	Normal Strong Mode	
t _{RISEF33}	Rise time, normal strong mode,	2	_	30	ns	10% to 90%	
t _{RISEF5}	Cload = 50 pF	2	_	22			
t _{FALLF33}	Fall time, normal strong mode,	2	_	30	ns	10% to 90%	
t _{FALLF5}	Cload = 50 pF	2	_	22			
t _{RISES}	Rise time, slow strong mode, Cload = 50 pF	7	27	-	ns	10% to 90%	
t _{FALLS}	Fall time, slow strong mode, Cload = 50 pF	7	22	_	ns	10% to 90%	

GPIO
Pin
Output
Voltage

trisef
trises
triality

Figure 7. GPIO Timing Diagram

AC Operational Amplifier Specifications

Table 16 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 16. AC Operational Amplifier Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
COIVII	Comparator mode response time, 50 mV overdrive	-	1	150	ns	

Note

14. Accuracy derived from Internal Main Oscillator with appropriate trim for V_{DD} range.



AC External Clock Specifications

Table 18 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 18. AC External Clock Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
F _{OSCEXT}	Frequency	0.093	_	24.24	MHz	
_	High period	20.6	-	5300	ns	
_	Low period	20.6	_	_	ns	
_	Power-up IMO to switch	150	_	-	μS	

AC Programming Specifications

Table 19 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40~^{\circ}\text{C} \le T_{\text{A}} \le 125~^{\circ}\text{C}$ or 3.0 V to 3.6 V and $-40~^{\circ}\text{C} \le \text{TA} \le 125~^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V or 3.3 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 19. AC Programming Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
t _{RSCLK}	Rise time of SCLK	1	_	20	ns	
t _{FSCLK}	Fall time of SCLK	1	_	20	ns	
t _{SSCLK}	Data setup time to falling edge of SCLK	40	_	_	ns	
t _{HSCLK}	Data hold time from falling edge 40 – ns of SCLK					
F _{SCLK}	Frequency of SCLK	0	_	8	MHz	
t _{ERASEB}	Flash erase time (block) -		10	40 [17]	ms	
t _{WRITE}	Flash block write time	_	40	160 ^[17]	ms	
t _{DSCLK}	Data Out delay from falling edge of SCLK	ay from falling edge – – 50 ns				
t _{PRGH}	(t _{ERASEB} + t _{WRITE}), hot		T _J ≥ 0 °C			
t _{PRGC} Total flash block program time (t _{ERASEB} + t _{WRITE}), cold		-	_	200 [17]	ms	T _J < 0 °C

Note

Document Number: 001-81890 Rev. *B

^{17.} For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) or other temperature sensor, and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note AN2015 for more information.



Development Tool Selection

This section presents the development tools available for the CY8C21x12 family.

Software

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer. Utilized by thousands of PSoC developers, this robust software has been facilitating PSoC designs for years. PSoC Designer is available free of charge at http://www.cypress.com. PSoC Designer comes with a free C compiler.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube in-circuit emulator and PSoC MiniProg. PSoC programmer is available free of charge at http://www.cypress.com.

Development Kits

All development kits can be purchased from the Cypress Online Store. The online store also has the most up-to-date information on kit contents, descriptions, and availability.

CY3215-DK Basic Development Kit

The CY3215-DK is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation, and the software interface allows you to run, halt, and single step the processor, and view the contents of specific memory locations. Advanced emulation features are also supported through PSoC Designer. The kit includes:

- ICE-Cube unit
- 28-pin PDIP emulation pod for CY8C29466-24PXI
- Two 28-pin CY8C29466-24PXI PDIP PSoC device samples
- PSoC designer software CD
- ISSP cable
- MiniEval socket programming and evaluation board
- Backward compatibility cable (for connecting to legacy pods)
- Universal 110/220 power supply (12 V)
- European plug adapter
- USB 2.0 cable
- Getting Started guide
- Development kit registration form

CY3280-BK1

The CY3280-BK1 Universal CapSense Control Kit is designed for easy prototyping and debug of CapSense designs with pre-defined control circuitry and plug-in hardware. The kit comes

with a control boards for CY8C20x34 and CY8C21x34 devices as well as a breadboard module and a button(5)/slider module.

The CY8C21x34 on-chip debugger device that is part of this kit is capable of emulating CY8C21x12 devices as well. Therefore, this kit can be used to evaluate and develop projects for CY8C21x12 devices.

Evaluation Tools

All evaluation tools can be purchased from the Cypress Online Store.

CY3210-PSoCEval1

The CY3210-PSoCEval1 kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, an RS-232 port, and plenty of breadboarding space to meet all of your evaluation needs. The kit includes:

- Evaluation board with LCD module
- MiniProg programming unit
- Two 28-pin CY8C29466-24PXI PDIP PSoC device samples
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable

CY3210-21X34 Evaluation Pod (EvalPod)

The CY3210-21X34 PSoC EvalPods are pods that connect to the ICE in-circuit emulator (CY3215-DK kit) to allow debugging capability. They can also function as a standalone device without debugging capability. The EvalPod has a 28-pin DIP footprint on the bottom for easy connection to development kits or other hardware. The top of the EvalPod has prototyping headers for easy connection to the device's pins. CY3210-21X34 provides evaluation of the CY8C21x34 PSoC device family.

The CY8C21x34 on-chip debugger device that is part of this kit is capable of emulating CY8C21x12 devices as well. Therefore, this kit can be used to evaluate CY8C21x12 devices.

Device Programmers

All device programmers can be purchased from the Cypress Online Store.

CY3210-MiniProg1

The CY3210-MiniProg1 kit allows a user to program PSoC devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg programming unit
- MiniEval socket programming and evaluation board
- 28-pin CY8C29466-24PXI PDIP PSoC device sample
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable



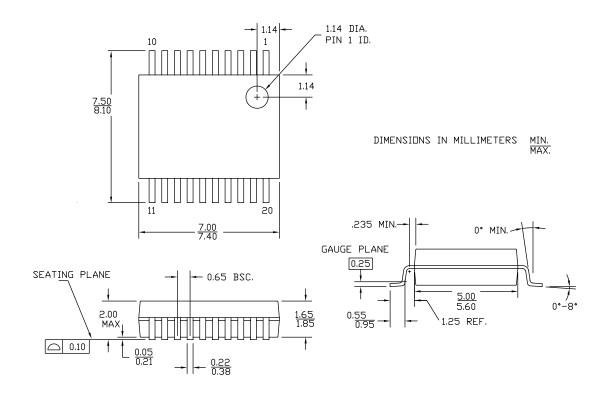
Packaging Information

This section illustrates the packaging specifications for the CY8C21x12 PSoC device, along with the thermal impedances for each package.

Important Note Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the emulator pod drawings at http://www.cypress.com.

Packaging Dimensions

Figure 9. 20-pin SSOP (210 Mils) O20.21 Package Outline, 51-85077



51-85077 *E



Thermal Impedances

Table 24. Thermal Impedances per Package

Package	Typical θ _{JA} ^[23]	Typical θ _{JC}
20-pin SSOP	117 °C/W	41 °C/W
28-pin SSOP	96 °C/W	39 °C/W

Solder Reflow Specifications

Table 25 shows the solder reflow temperature limits that must not be exceeded.

Table 25. Solder Reflow Specifications

Package	Maximum Peak Temperature (T _C)	Maximum Time above T _C – 5 °C		
20-pin SSOP	260 °C	30 seconds		
28-pin SSOP	260 °C	30 seconds		



Reference Information

Reference Documents

CY8CPLC20, CY8CLED16P01, CY8C29x66, CY8C27x43, CY8C24x94, CY8C24x23, CY8C24x23A, CY8C22x13, CY8C21x34, CY8C21x23, CY7C64215, CY7C603xx, CY8CNP1xx, and CYWUSB6953 PSoC® Programmable System-on-Chip Technical Reference Manual (TRM) (001-14463)

Design Aids – Reading and Writing PSoC® Flash – AN2015 (001-40459)



An oscillator in which the frequency is controlled by a piezoelectric crystal. Typically a piezoelectric crystal is less crystal oscillator

sensitive to ambient temperature than other circuit components.

check (CRC)

cyclic redundancy A calculation used to detect errors in data communications, typically performed using a linear feedback shift register. Similar calculations may be used for a variety of other purposes such as data compression.

data bus A bi-directional set of signals used by a computer to convey information from a memory location to the central

processing unit and vice versa. More generally, a set of signals used to convey data between digital functions.

A hardware and software system that allows you to analyze the operation of the system under development. A debugger

debugger usually allows the developer to step through the firmware one step at a time, set break points, and

analyze memory.

dead band A period of time when neither of two or more signals are in their active state or in transition.

digital blocks The 8-bit logic blocks that can act as a counter, timer, serial receiver, serial transmitter, CRC generator,

pseudo-random number generator, or SPI.

digital-to-analog converter (DAC)

A device that changes a digital signal to an analog signal of corresponding magnitude. The analog-to-digital converter (ADC) performs the reverse operation.

duty cycle The relationship of a clock period high time to its low time, expressed as a percent.

emulator Duplicates (provides an emulation of) the functions of one system with a different system, so that the second

system appears to behave like the first system.

external reset (XRES)

An active high signal that is driven into the PSoC device. It causes all operation of the CPU and blocks to stop and return to a pre-defined state.

An electrically programmable and erasable, non-volatile technology that provides you the programmability and flash

data storage of EPROMs, plus in-system erasability. Non-volatile means that the data is retained when power is

off.

flash block The smallest amount of flash ROM space that may be programmed at one time and the smallest amount of flash

space that may be protected.

frequency The number of cycles or events per unit of time, for a periodic function.

The ratio of output current, voltage, or power to input current, voltage, or power, respectively. Gain is usually gain

expressed in dB.

I²C A two-wire serial computer bus by Philips Semiconductors (now NXP Semiconductors). It is used to connect

low-speed peripherals in an embedded system. The original system was created in the early 1980s as a battery control interface, but it was later used as a simple internal bus system for building control electronics. I2C uses only two bi-directional pins, clock and data, both running at the V_{DD} supply voltage and pulled high with resistors.

The bus operates up to 100 kbits/second in standard mode and 400 kbits/second in fast mode.

ICE The in-circuit emulator that allows you to test the project in a hardware environment, while viewing the debugging

device activity in a software environment (PSoC Designer).

input/output (I/O) A device that introduces data into or extracts data from a system.

A suspension of a process, such as the execution of a computer program, caused by an event external to that interrupt

process, and performed in such a way that the process can be resumed.

A block of code that normal code execution is diverted to when the CPU receives a hardware interrupt. Many interrupt service routine (ISR) interrupt sources may each exist with its own priority and individual ISR code block. Each ISR code block ends

with the RETI instruction, returning the device to the point in the program where it left normal program execution.



jitter

- 1. A misplacement of the timing of a transition from its ideal position. A typical form of corruption that occurs on serial data streams.
- The abrupt and unwanted variations of one or more signal characteristics, such as the interval between successive pulses, the amplitude of successive cycles, or the frequency or phase of successive cycles.

low voltage detect A circuit that senses V_{DD} and provides an interrupt to the system when V_{DD} falls below a selected threshold. (LVD)

M8C An 8-bit Harvard-architecture microprocessor. The microprocessor coordinates all activity inside a PSoC by

interfacing to the flash, SRAM, and register space.

master device A device that controls the timing for data exchanges between two devices. Or when devices are cascaded in

width, the master device is the one that controls the timing for data exchanges between the cascaded devices and an external interface. The controlled device is called the *slave device*.

microcontroller An integrated circuit chip that is designed primarily for control systems and products. In addition to a CPU, a microcontroller typically includes memory, timing circuits, and I/O circuitry. The reason for this is to permit the

realization of a controller with a minimal quantity of chips, thus achieving maximal possible miniaturization. This in turn, reduces the volume and the cost of the controller. The microcontroller is normally not used for

general-purpose computation as is a microprocessor.

mixed-signal The reference to a circuit containing both analog and digital techniques and components.

modulator A device that imposes a signal on a carrier.

noise 1. A disturbance that affects a signal and that may distort the information carried by the signal.

2. The random variations of one or more characteristics of any entity such as voltage, current, or data.

oscillator A circuit that may be crystal controlled and is used to generate a clock frequency.

parity A technique for testing transmitted data. Typically, a binary digit is added to the data to make the sum of all the

digits of the binary data either always even (even parity) or always odd (odd parity).

phase-locked loop (PLL)

An electronic circuit that controls an oscillator so that it maintains a constant phase angle relative to a reference

signal.

pinouts The pin number assignment: the relation between the logical inputs and outputs of the PSoC device and their

physical counterparts in the printed circuit board (PCB) package. Pinouts involve pin numbers as a link between

schematic and PCB design (both being computer generated files) and may also involve pin names.

port A group of pins, usually eight.

power-on reset (POR)

A circuit that forces the PSoC device to reset when the voltage is below a pre-set level. This is one type of hardware

rese

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of Cypress.

PSoC Designer™ The software for Cypress' Programmable System-on-Chip technology.

pulse width modulator (PWM)

An output in the form of duty cycle which varies as a function of the applied value.

RAM An acronym for random access memory. A data-storage device from which data can be read out and new data

can be written in.

register A storage device with a specific capacity, such as a bit or byte.



reset A means of bringing a system back to a known state. See hardware reset and software reset.

ROM An acronym for read only memory. A data-storage device from which data can be read out, but new data cannot

be written in.

serial 1. Pertaining to a process in which all events occur one after the other.

2. Pertaining to the sequential or consecutive occurrence of two or more related activities in a single device or

channel.

settling time The time it takes for an output signal or value to stabilize after the input has changed from one value to another.

shift register A memory storage device that sequentially shifts a word either left or right to output a stream of serial data.

slave device A device that allows another device to control the timing for data exchanges between two devices. Or when

devices are cascaded in width, the slave device is the one that allows another device to control the timing of data exchanges between the cascaded devices and an external interface. The controlling device is called the master

device.

SRAM An acronym for static random access memory. A memory device where you can store and retrieve data at a high

rate of speed. The term static is used because, after a value is loaded into an SRAM cell, it remains unchanged

until it is explicitly altered or until power is removed from the device.

SROM An acronym for supervisory read only memory. The SROM holds code that is used to boot the device, calibrate

circuitry, and perform flash operations. The functions of the SROM may be accessed in normal user code,

operating from flash.

stop bit A signal following a character or block that prepares the receiving device to receive the next character or block.

synchronous 1. A signal whose data is not acknowledged or acted upon until the next active edge of a clock signal.

2. A system whose operation is synchronized by a clock signal.

tristate A function whose output can adopt three states: 0, 1, and Z (high-impedance). The function does not drive any

value in the Z state and, in many respects, may be considered to be disconnected from the rest of the circuit,

allowing another output to drive the same net.

UART A UART or universal asynchronous receiver-transmitter translates between parallel bits of data and serial bits.

user modules Pre-built, pre-tested hardware/firmware peripheral functions that take care of managing and configuring the lower

level analog and digital PSoC blocks. User modules also provide high level API (Application Programming

Interface) for the peripheral function.

user space The bank 0 space of the register map. The registers in this bank are more likely to be modified during normal

program execution and not just during initialization. Registers in bank 1 are most likely to be modified only during

the initialization phase of the program.

 V_{DD} A name for a power net meaning "voltage drain". The most positive power supply signal. Usually 5 V or 3.3 V.

V_{SS} A name for a power net meaning "voltage source." The most negative power supply signal.

watchdog timer A timer that must be serviced periodically. If it is not serviced, the CPU resets after a specified period of time.



Document History Page

Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change
**	3705964	MASJ	08/09/2012	New data sheet.
*A	4008934	KAUL	05/23/2013	Updated Features. Updated PSoC Functional Overview (Updated The Digital System).
				Updated Electrical Specifications (Updated DC Electrical Characteristics (Updated DC Chip-Level Specifications (Updated Table 8), updated DC GPIO Specifications (Updated Table 9), updated DC Operational Amplifier Specifications, updated DC Analog Mux Bus Specifications, updated DC POR and LVD Specifications, updated DC Programming Specifications (Updated Table 13)), updated AC Electrical Characteristics (Updated AC Chip-Level Specifications (Updated Table 14), updated AC GPIO Specifications (Updated Table 15), updated AC Operational Amplifier Specifications, updated AC Digital Block Specifications (Updated Table 17), updated AC External Clock Specifications, updated AC Programming Specifications, updated AC I2C Specifications)).
				Updated Packaging Information: Updated Tape and Reel Information: spec 51-51101 – Changed revision from *B to *C.
*B	4265204	JICG	01/28/2014	Removed 'CY3207ISSP In-System Serial Programmer (ISSP)' section.